

May 1992 Revised November 1999

74ABT2244

Octal Buffer/Line Driver with 25 Ω Series Resistors in the Outputs

General Description

The ABT2244 is an octal buffer and line driver designed to drive the capacitive inputs of MOS memory drivers, address drivers, clock drivers, and bus-oriented transmit-

The 25Ω series resistors in the outputs reduce ringing and eliminate the need for external resistors.

Features

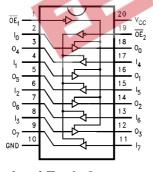
- Guaranteed latchup protection
- lacktriangle High impedance glitch-free bus loading during entire power up and power down cycle
- Nondestructive hot insertion capability

Ordering Code:

		31. GP
Order Number	Package Number	Package Description
74ABT2244CSC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body
74ABT2244CSJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74ABT2244CMSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74ABT2244CMTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74ABT2244CPC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices are also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

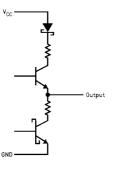
Connection Diagram



Pin Descriptions

Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$	Output Enable Input (Active LOW)
I ₀ -I ₇	Inputs
O ₀ –O ₇	Outputs

Schematic of Each Output



Truth Table

OE ₁	I ₀₋₃	O ₀₋₃	OE ₂	I ₄₋₇	04-7
Н	Х	Z	Н	Х	Z
L	Н	Н	L	Н	Н
L	L	L	L	L	L

- H = HIGH Voltage Level
- L = LOW Voltage Level X = Immaterial
- Z = High Impedance

Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions

Storage Temperature $-65^{\circ}\text{C} \text{ to } +150^{\circ}\text{C}$

Ambient Temperature under Bias -55° C to +125 $^{\circ}$ C Junction Temperature under Bias -55° C to +150 $^{\circ}$ C

V_{CC} Pin Potential to Ground Pin -0.5V to +7.0V

Voltage Applied to Any Output

in the Disabled or

Power-off State -0.5 V to 5.5 V in the HIGH State $-0.5 \text{V to } \text{V}_{\text{CC}}$

Current Applied to Output

in LOW State (Max) $\qquad \qquad \text{twice the rated I}_{\text{OL}} \, (\text{mA})$

DC Latchup Source Current

(Across Comm Operating Range) —300 mA Over Voltage Latchup (I/O) 10V

Free Air Ambient Temperature -40°C to $+85^{\circ}\text{C}$ Supply Voltage +4.5V to +5.5V

Minimum Input Edge Rate (ΔV/Δt)

Data Input 50 mV/ns
Enable Input 20 mV/ns

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

DC Electrical Characteristics

Symbol	P	arameter	Min	Тур	Max	Units	V _{CC}	Conditions		
V _{IH}	Input HIGH Volt	age	2.0		20 1	V	1	Recognized HIGH Signal		
V _{IL}	Input LOW Volta	age		4	0.8	V		Recognized LOW Signal		
V _{CD}	Input Clamp Dic	ode Voltage			-1.2	V	Min	I _{IN} = -18 mA		
V _{OH}	Output HIGH		2.5			V	Min	$I_{OH} = -3 \text{ mA}$		
			2.0			V	Min	$I_{OH} = -32 \text{ mA}$		
V _{OL}	Output LOW Vo	Itage			0.8	V	Min	I _{OL} = 15 mA		
I _{IH}	Input HIGH Cur	rent	\mathcal{A}		1	μА	Max	V _{IN} = 2.7V (Note 4)		
					1	μΑ	IVICA	$V_{IN} = V_{CC}$		
I _{BVI}	Input HIGH Cur	rent Breakdown Test			7	μΑ	Max	V _{IN} = 7.0V		
I _{IL}	Input LOW Curr	ent			-1	μА	Max	V _{IN} = 0.5V (Note 4)		
					-1	μΑ	IVICA	$V_{IN} = 0.0V$		
V _{ID}	Input Leakage T	est	475			V	0.0	$I_{ID} = 1.9 \mu A$		
			473			·	0.0	All Other Pins Grounded		
I _{OZH}	Output Leakage	Current			10	μΑ	0 – 5.5V	V _{OUT} = 2.7V; OE n = 2.0V		
I _{OZL}	Output Leakage	Current			-10	μΑ	0 – 5.5V	V _{OUT} = 0.5V; OE n = 2.0V		
Ios	Output Short-Ci	rcuit Current	-100		-275	mA	Max	V _{OUT} = 0.0V		
I _{CEX}	Output HIGH Le	akage Current			50	μΑ	Max	$V_{OUT} = V_{CC}$		
I _{ZZ}	Bus Drainage To	est			100	μΑ	0.0	V _{OUT} = 5.5V; All Others GND		
I _{CCH}	Power Supply C	Current			50	μΑ	Max	All Outputs HIGH		
I _{CCL}	Power Supply C	Current			30	mA	Max	All Outputs LOW		
I _{CCZ}	Power Supply C	Current			50	μΑ	Max	OEn = V _{CC}		
								All Others at V _{CC} or GND		
I _{CCT}	Additional	Outputs Enabled			2.5	mA		$V_1 = V_{CC} - 2.1V$		
	I _{CC} /Input	Outputs 3-STATE			2.5	mA	Max	Enable Input V _I = V _{CC} - 2.1V		
		Outputs 3-STATE			50	μΑ		Data Input V _I = V _{CC} - 2.1V		
								All Others at V _{CC} or GND		
I _{CCD}	Dynamic I _{CC}	No Load				mA/	Max	Outputs OPEN		
	(Note 4)				0.1	MHz		OEn = GND (Note 3)		
								One Bit Toggling, 50% Duty Cycle		

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Note 3: For 8 bits toggling, $\rm I_{CCD} < 0.8~mA/MHz.$

Note 4: Guaranteed, but not tested.

AC Electrical Characteristics

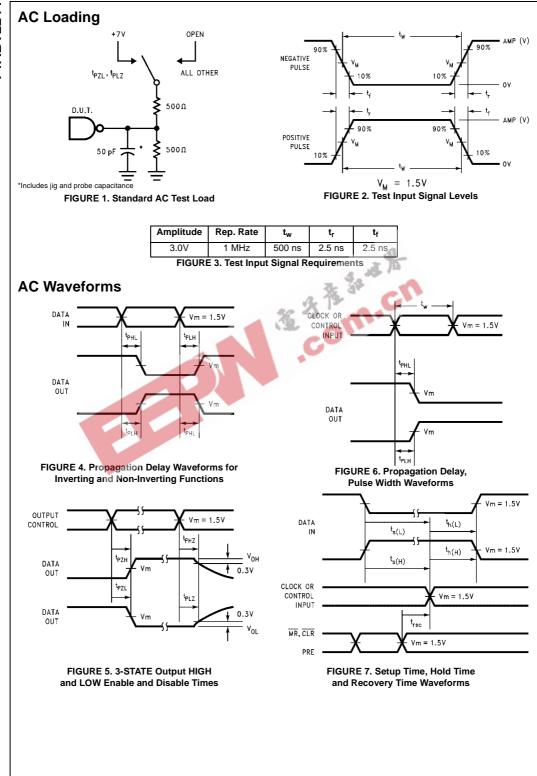
(SOIC and SSOP Package)

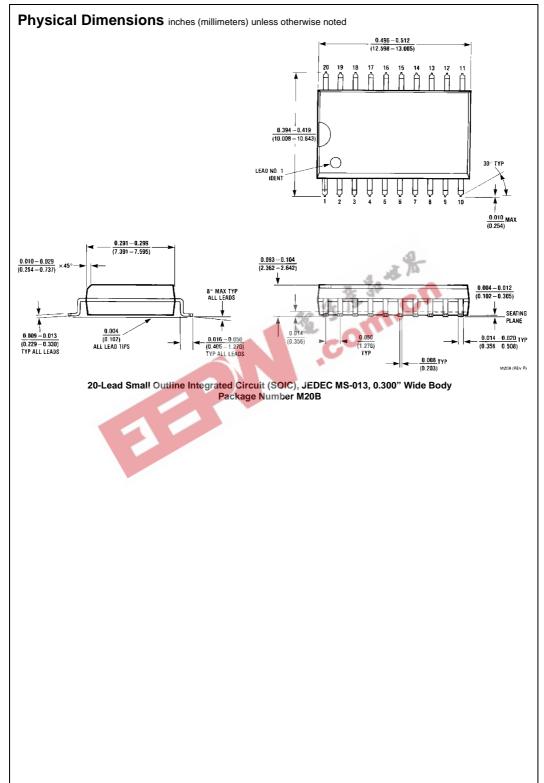
Symbol	Parameter	$T_A = +25$ °C $V_{CC} = +5V$ $C_L = 50 \text{ pF}$			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V} - 5.5\text{V}$ $C_L = 50 \text{ pF}$		Units
		Min	Тур	Max	Min	Max	
t _{PLH}	Propagation	1.0	2.2	3.9	1.0	3.9	ns
t _{PHL}	Delay Data to Outputs	1.0	2.9	4.4	1.0	4.4	115
t _{PZH}	Output Enable	1.5	3.7	6.0	1.5	6.0	na
t _{PZL}	Time	2.1	4.3	7.0	2.1	7.0	ns
t _{PHZ}	Output Disable	1.7	3.5	5.8	1.7	5.8	20
t_{PLZ}	Time	1.7	3.7	5.8	1.7	5.8	ns

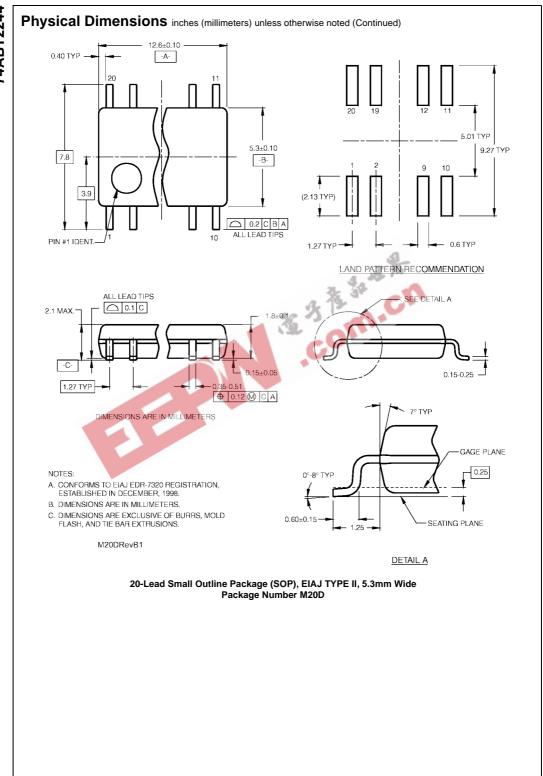
Capacitance

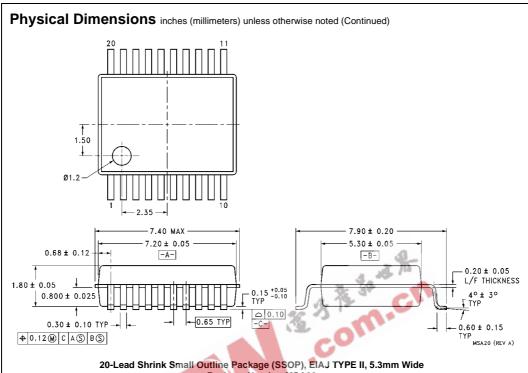
Symbol	Parameter	Тур	Units	Conditions T _A = 25°C
C _{IN}	Input Capacitance	5.0	pF	V _{CC} = 0V
C _{OUT} (Note 5)	Output Capacitance	9.0	pF	V _{CC} = 5.0V
, ce 3. 9 ₀₀ 5	easured at frequency f = 1 MHz, per MIL-STD-		CO	n.cn



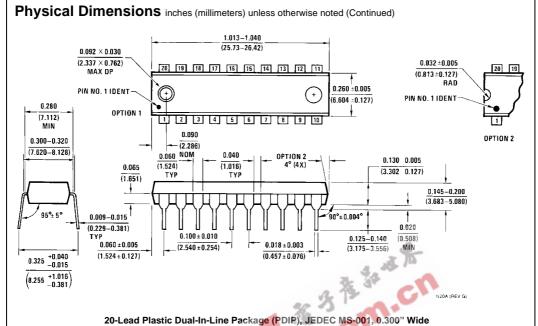








20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide Package Number MSA20



Package N<mark>umb</mark>er N20A

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9